October 2007



FFP04S60S

Features

- High Speed Switching, $t_{rr} < 25$ ns @ $I_F = 4$ A
- High Reverse Voltage and High Reliability
- · RoHS compliant

Applications

- · General Purpose
- Switching Mode Power Supply
- · Boost Diode in continuous mode power factor corrections
- · Power switching circuits



STEALTHTM II Rectifier

4A, 600V STEALTH™ II Rectifier

The FFP04S60S is STEALTH™ II rectifier with soft recovery characteristics. It is silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as freewheeling of boost diode in switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.



1. Cathode

2. Anode



1. Cathode 2. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V_{RRM}	Peak Repetitive Reverse Voltage	600	V	
V_{RWM}	Working Peak Reverse Voltage	600	V	
V_R	DC Blocking Voltage	600	V	
I _{F(AV)}	Average Rectified Forward Current @ T _C = 127°C	4	Α	
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	40	А	
T _J , T _{STG}	Operating and Storage Temperature Range	-65 to +150	οС	

Thermal Characteristics

Symbol	Parameter	Ratings	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.6	°C/W

Package Marking and Ordering Information

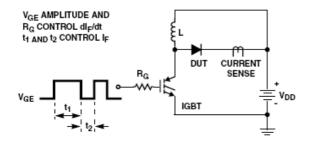
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F04S60S	FFP04S60STU	TO-220-2L	-	-	50

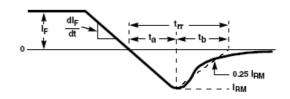
Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} 1	$I_F = 4A$ $I_F = 4A$	$T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 125^{\rm o}{\rm C}$		2.2 1.7	2.6	V
I _{RM} 1	V _R = 600V V _R = 600V	$T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 125^{\rm o}{\rm C}$			100 500	μА
t _{rr}	$I_F = 1A$, di/dt = 100A/ μ s, $V_R = 30V$	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	16	23	ns
t _{rr} I _{rr} S factor Q _{rr}	$I_F = 4A$, di/dt = 200A/ μ s, $V_R = 390V$	T _C = 25°C		18 2 0.7 18	25 - - -	ns A nC
t _{rr} I _{rr} S factor Q _{rr}	$I_F = 4A$, di/dt = 200A/ μ s, $V_R = 390V$	T _C = 125°C		45 2.8 1.8 64		ns A nC
W _{AVL}	Avalanche Energy (L = 40mH)	ı	10	=	-	mJ

Notes: 1: Pulse: Test Pulse width = 300μ s, Duty Cycle = 2%

Test Circuit and Waveforms



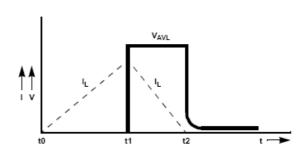


L = 40mH

R < 0.1Ω V_{DD} = 50V

 $\begin{aligned} &\mathsf{EAVL} = 1/2\mathsf{L}12 \; [\mathsf{V}_{\mathsf{R}(\mathsf{AVL})}/(\mathsf{V}_{\mathsf{R}(\mathsf{AVL})} \cdot \mathsf{V}_{\mathsf{DD}})] \\ &\mathsf{Q1} = \mathsf{IGBT} \; (\mathsf{BV}_{\mathsf{CES}} > \mathsf{DUT} \; \mathsf{V}_{\mathsf{R}(\mathsf{AVL})}) \end{aligned}$

CURRENT SENSE V_{DD}



Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop vs. Forward Current

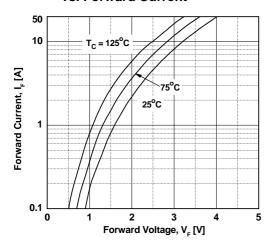


Figure 3. Typical Junction Capacitance

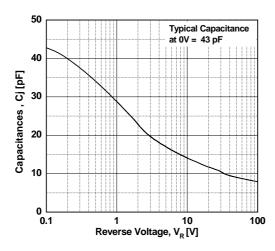


Figure 5. Typical Reverse Recovery Current vs. di/dt

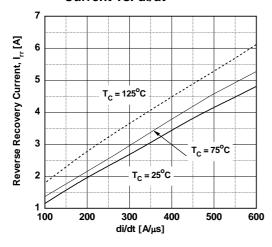


Figure 2. Typical Reverse Current vs. Reverse Voltage

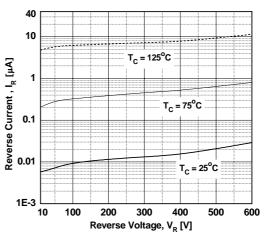


Figure 4. Typical Reverse Recovery Time vs. di/dt

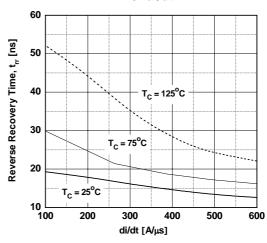
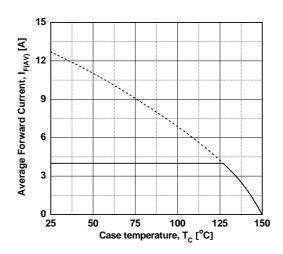


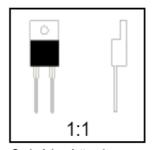
Figure 6. Forward Current Derating Curve



Mechanical Dimensions

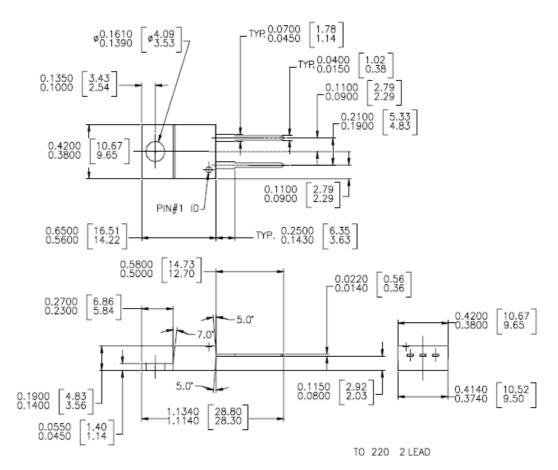
TO-220-2L





Scale 1:1 on letter size paper Dimensions shown below are in: inches [millimeters]

Part Weight per unit (gram): 2.24



NOTE: UNLESS OTHERWISE SPECIFIED

1. STANDARD LEAD FINISH: 200 MICROINCHES / 5.08 MICRON MINIMUM LEAD / TIN 15/85 ON OLIN 194 COPPER OR EQUIVALENT

2. DIMENSION BASED ON JEDEC STANDARD TO-220 VARIATION AB, ISSUE J, DATED 3/24/87

Dimensions in Millimeters



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Rev. I31